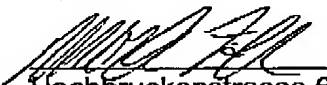
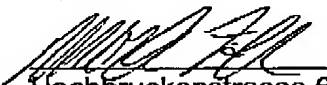
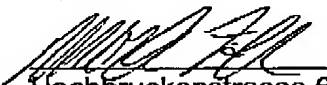


COMBINED DECLARATION FOR PATENT APPLICATION AND POWER OF ATTORNEY (Includes Reference to PCT International Applications)	Attorney's Docket Number PC 32103																
<p>As a below named inventor, I hereby declare that:</p> <p>My residence, post office address and citizenship are as stated below next to my name,</p> <p>I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:</p> <p style="text-align: center;"><u>ORAL COMPOSITION APPLICATOR DEVICES INCLUDING PIERCING SECTION AND RELATED METHODS</u></p> <p>the specification of which (check only one item below):</p> <p><input type="checkbox"/> is attached hereto.</p> <p><input checked="" type="checkbox"/> was filed as United States application Serial No <u>10/826,812</u> on <u>April 16, 2004</u> and was amended on _____ (if applicable).</p> <p><input type="checkbox"/> was filed as PCT international application Number _____ on _____ and was amended on _____ (if applicable).</p> <p>I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 including for continuation-in-part applications material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.</p> <p>I hereby claim foreign priority benefits under United States Code 37 CFR § 119(a-d) or § 365(b) of any foreign application(s) for patent or inventor's certificate, or § 365(a), or of any PCT international application which designated at least one country other than the United States of America listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate or any PCT international application having a filing date before that of the application of which priority is claimed: Prior Foreign Application(s)</p> <table border="1" style="width: 100%; border-collapse: collapse;"><thead><tr><th style="width: 30%;">APPLICATION NUMBER</th><th style="width: 30%;">COUNTRY (if PCT, indicate "PCT")</th><th style="width: 20%;">DATE OF FILING (day, month, year)</th><th style="width: 20%;">PRIORITY CLAIMED</th></tr></thead><tbody><tr><td> </td><td> </td><td> </td><td><input type="checkbox"/> yes <input type="checkbox"/> no</td></tr><tr><td> </td><td> </td><td> </td><td><input type="checkbox"/> yes <input type="checkbox"/> no</td></tr></tbody></table> <p>I hereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below:</p> <table border="1" style="width: 100%; border-collapse: collapse;"><thead><tr><th style="width: 50%;">APPLICATION NUMBER</th><th style="width: 50%;">DATE OF FILING</th></tr></thead><tbody><tr><td> </td><td> </td></tr></tbody></table>		APPLICATION NUMBER	COUNTRY (if PCT, indicate "PCT")	DATE OF FILING (day, month, year)	PRIORITY CLAIMED				<input type="checkbox"/> yes <input type="checkbox"/> no				<input type="checkbox"/> yes <input type="checkbox"/> no	APPLICATION NUMBER	DATE OF FILING		
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Combined Declaration For Patent Application and Power of Attorney (Continued) (Includes Reference to PCT International Applications)				Attorney Docket Number PC 32103																																																												
<p>I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) or § 365(c) of any PCT international application designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information which is material to patentability as defined in 37 CFR, §1.56(a) which became available between the filing date of the prior application(s) and the national or PCT International filing date of this application:</p>																																																																
<p>PRIOR U.S. APPLICATIONS OR PCT INTERNATIONAL APPLICATIONS DESIGNATING THE U.S. FOR BENEFIT UNDER 35 U.S.C. 120:</p> <table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th colspan="2" style="text-align: center;">U.S. APPLICATIONS</th> <th colspan="3" style="text-align: center;">STATUS (Check one)</th> </tr> <tr> <th style="text-align: center;">U.S. APPLICATION NUMBER</th> <th style="text-align: center;">U.S. FILING DATE</th> <th style="text-align: center;">PATENTED</th> <th style="text-align: center;">PENDING</th> <th style="text-align: center;">ABANDONED</th> </tr> </thead> <tbody> <tr><td> </td><td> </td><td> </td><td> </td><td> </td></tr> <tr><td> </td><td> </td><td> </td><td> </td><td> </td></tr> <tr><td> </td><td> </td><td> </td><td> </td><td> </td></tr> <tr><td> </td><td> </td><td> </td><td> </td><td> </td></tr> </tbody> </table> <table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th colspan="3" style="text-align: center;">PCT APPLICATIONS DESIGNATING THE U.S.</th> <th> </th> <th> </th> <th> </th> </tr> <tr> <th style="text-align: center;">PCT APPLICATION NO.</th> <th style="text-align: center;">PCT FILING DATE</th> <th style="text-align: center;">U.S. SERIAL NUMBERS ASSIGNED (if any)</th> <th> </th> <th> </th> <th> </th> </tr> </thead> <tbody> <tr><td> </td><td> </td><td> </td><td> </td><td> </td><td> </td></tr> <tr><td> </td><td> </td><td> </td><td> </td><td> </td><td> </td></tr> <tr><td> </td><td> </td><td> </td><td> </td><td> </td><td> </td></tr> </tbody> </table>					U.S. APPLICATIONS		STATUS (Check one)			U.S. APPLICATION NUMBER	U.S. FILING DATE	PATENTED	PENDING	ABANDONED																					PCT APPLICATIONS DESIGNATING THE U.S.						PCT APPLICATION NO.	PCT FILING DATE	U.S. SERIAL NUMBERS ASSIGNED (if any)																					
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<p>POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. (List name and registration number Charles W. Ashbrook (Reg. No. 27,610), Evan J. Federman (Reg. No.37,060), Mehdi Ganjeizadeh (Reg. No. 47,585), Suzanne M. Harvey (Reg. No. 42,640), David R. Kurlandsky (Reg. 41,505), Darryl Little (Reg. No. 40,703), Barry Jacobsen (Reg. No. 43,689), Claude F. Purchase, Jr. (Reg. No. 47,871), Francis J. Tinney (Reg. No. 33,069), Linda Vag (Reg. No. 32,071), Kenneth G. Lemke (Reg. No. 47,746), Erika Singleton Wilson (Reg. No. 52,368)</p>																																																																
Send Correspondence to: Kenneth G. Lemke, Legal Division, Warner-Lambert Company, 201 Tabor Road, Morris Plains, NJ 07950			Direct Telephone Calls to: Kenneth G. Lemke 973 385-6243																																																													
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FULL NAME OF INVENTOR : Aaron Richard Sevier

Signature of Inventor : 

Date

5/21/04

Residence :

3850 25th Street Apt. #3
San Francisco, CA 94114

Citizenship :

USA

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FULL NAME OF INVENTOR : John Smith

Signature of Inventor :

Date

Residence :

1981 14th Avenue
San Francisco, CA 94116

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FULL NAME OF INVENTOR : Nancy J. Serpiello

Signature of Inventor :

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Residence :

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Menlo Park, CA 94025

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FULL NAME OF INVENTOR : William Smith

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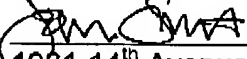
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FULL NAME OF INVENTOR : William Smith

Signature of Inventor : William E. Smith Date May 24, 2004Residence : 1617 Queen Charlotte Drive #5
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